INFORMATION DISCLOSURE CITATION

(USE SEVERAL SHEETS IF NECESSARY)

ATTY DOCKET NO.	SERIAL NO.
POU920040003US1	UNKNOWN
APPLICANT(S)	D Mail Label # = 6363646791 US
CHU ET AL.	ER363646791 US
FILING DATE	GROUP

UNKNOWN

HEREWITH

			U.S. PATEN	T DOCUMENT	rs				
EXAMINER NITIAL		DOCUMENT NUMBER	DATE		NAME	CLAS	s sı	JBCLASS	FILING DATE IF APPROPRIATE
	AA	5,036,677	08/06/1991	Neuenfel	Neuenfeldt et al.		25	59	
	AB	5,884,489	03/23/1999	Hughes e	Hughes et al.		3.	4	
	AC	6,167,947 B1	01/02/2001	Hokanso	n et al.	165	80).3	
	AD	6,233,959 B1	05/22/2001	Kang et a	al.	62	2.	59.2	
	AE	6,542,361 B2	04/01/2003	Paradis	,	361	68	37	
			FOREIGN PAT	ENT DOCUMI	ENTS				
		DOCUMENT NUMBER	DATE	COUNTRY	COUNTRY CLASS SUBCL		SUBCLASS NO YE		RANSLATION ABSTRACT
	AF	GB 2,129,113 A	10/12/1983	GB	F25D	13/00	Х		
		OTHER DO	CUMENTS (Including	Author, Title, D	ate, Pertinent	Pages, Etc.)	<u> </u>		
	AG	Chu et al., "Method and Apparatus For Combined Air and Liquid Cooling Of Stacked Electronics Components", pending U.S. patent application, Serial No. 10/303,284, filed November 25, 2002.							
	AH	Chu et al., "Method and Sy application, Serial No. 10/6			acks Using	g Pre-Cooled	Air", p	ending	U.S. patent

EXAMINER	DATE CONSIDERED						
EXAMINER: Initial here if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							